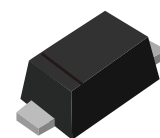


FEATURES

- | 150W Peak Pulse Power per Line (tp=8/20μs)
- | Protects One Power or I/O Port
- | Working voltages : 3.3 V
- | Low operating and clamping voltages
- | Solid-state silicon avalanche technology

APPLICATIONS

- | Notebooks,Desktops,Servers and Video
- | Graphics Cards Display Ports
- | USB Power & Data Line Protection
- | Monitors and Flat Panel Displays
- | I²C Bus Protection
- | Portable Instrumentation
- | Set Top Box



SOD-723



Marking

IEC COMPATIBILITY

- | IEC61000-4-2 (ESD) ±15kV (air), ±8kV (contact)
- | IEC61000-4-4 (EFT) 40A (5/50ns)

APPROVALS

RoHS	Compliance with 2011/65/EU
HF	Compliance with IEC61249-2-21:2003



Schematic Symbol

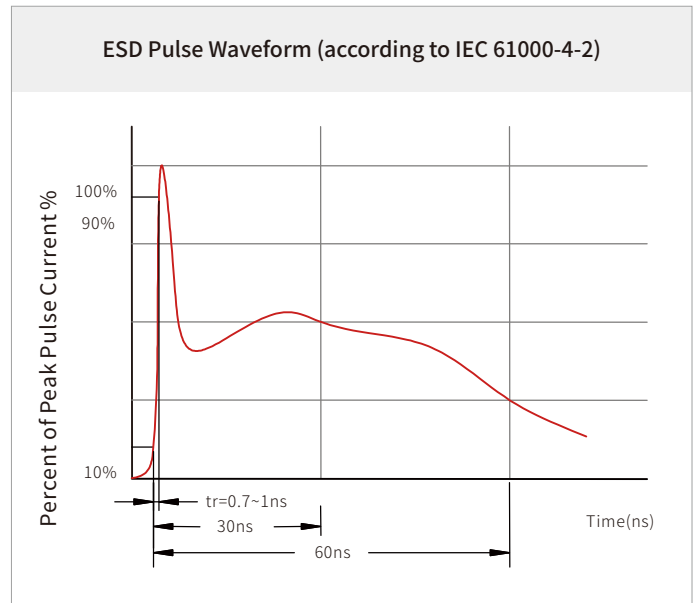
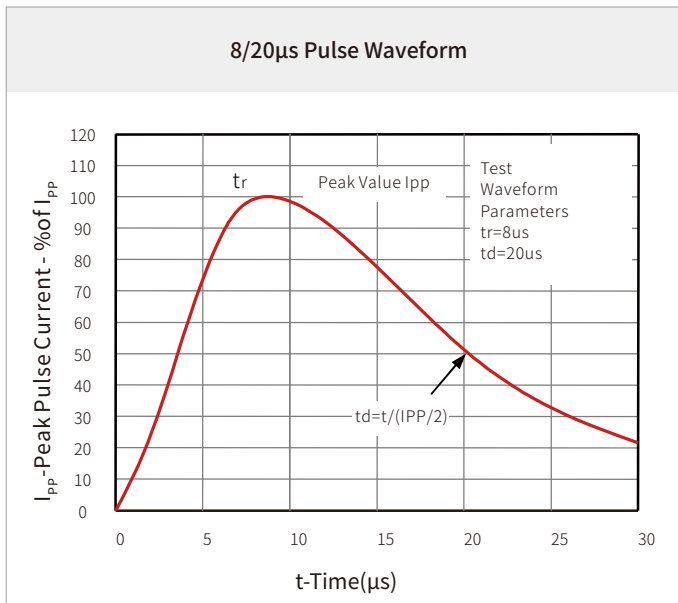
THERMAL CONSIDERATIONS

Symbol	Parameter	Value	Unit
P _{pp}	Peak Pulse Power (tp=8/20μs waveform)	150	Watts
T _J	Operating Temperature Range	-55 to +150	°C
T _{STG}	Storage Temperature Range	-55 to +150	°C

ELECTRICAL CHARACTERISTICS

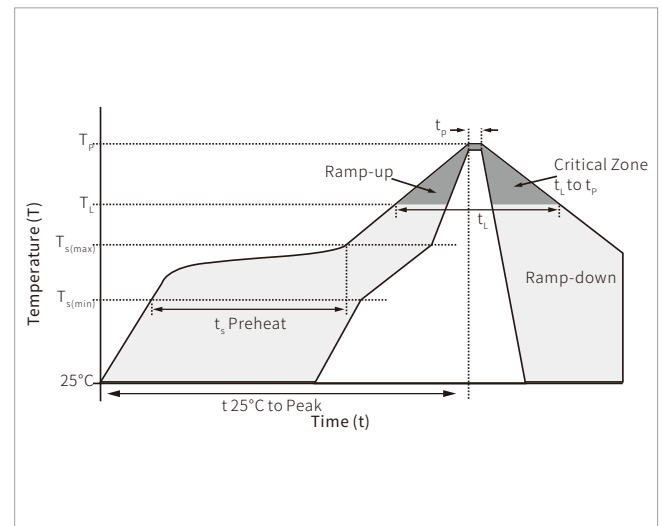
Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
V _{RWM}	Reverse Stand-off Voltage				3.3	V
V _{BR}	Reverse Breakdown Voltage	I _T =1mA	4			V
I _R	Reverse Leakage Current	V _{RWM} =3.3V			1	μA
V _C	Clamping Voltage (Tp=8/20us)	I _{pp} =1A,tp=8/20us			9.8	V
V _C	Clamping Voltage (Tp=8/20us)	I _{pp} =12A,tp=8/20us			13	V
I _{pp}	Peak Pulse Current (Tp=8/20us)	tp=8/20us			12	A
C _J	Off State Junction Capacitance	V _R =0V, f=1MHz			120	pF

CHARACTERISTIC CURVES

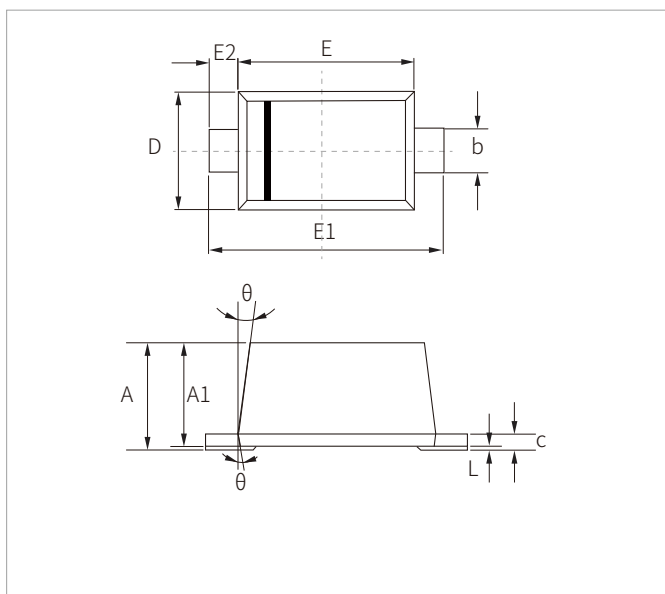


SOLDERING PARAMETERS

Reflow Condition		Lead-free assembly
Pre Heat	Temperature Max ($T_{s(min)}$)	150°C
	Temperature Max ($T_{s(max)}$)	200°C
	Time (min to max) (t_s)	60 – 180 secs
Average ramp up rate (Liquidus Temp (T_L) to peak)		3°C/second max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/second max
Reflow	Temperature (T_L) (Liquidus)	217°C
	Time (min to max) (t_L)	60 – 150 seconds
Peak Temperature (T_p)		260°C
Time within 5°C of actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T_p)		8 minutes max.
Do not exceed		260°C

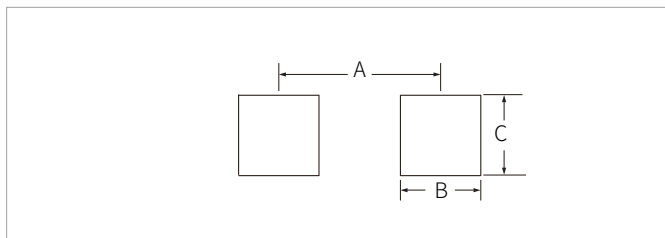


SOD-723 PACKAGE INFORMATION



Ref.	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	0.525	0.650	0.021	0.026
A1	0.515	0.580	0.020	0.023
b	0.250	0.350	0.010	0.014
c	0.080	0.150	0.003	0.006
D	0.550	0.650	0.022	0.026
E	0.900	1.100	0.035	0.043
E1	1.300	1.500	0.051	0.059
E2	0.200REF		0.008REF	
L	0.010	0.070	0.001	0.003
θ	7° REF		7° REF	

RECOMMENDED PAD LAYOUT DIMENSIONS



Ref.	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	1.21	1.31	0.048	0.052
B	0.55	0.65	0.022	0.026
C	0.65	0.75	0.026	0.030

ORDERING INFORMATION

Part Number	Component Package	QTY/Reel	Reel Size
SE7D15U3.3A	SOD-723	8000PCS	7"

Headquarters

No.3387 Shendu Road
Pujiang I&E Park
Minhang Shanghai China
201000

Hotline

400-021-5756

Web

<https://www.semiware.com>

Sales Center

Tel: 86-21-3463-7458
Email: sales18@semiware.com

Customer Service

Tel: 86-21-5484-1001
Email: sales17@semiware.com

Technical Support

Tel: 86-21-3463-7654
Email: fae01@semiware.com

Complaint & Suggestions

Tel: 86-21-3463-7172
Ext: 8868
Email: cs03@semiware.com

By QR Code

Website



Wechat

To find your local partner within Semiware's global website: www.semiware.com

© 2022 Semiware Semiconductor Inc.

The content of this document has been carefully checked and understood. However, neither Semiware nor its subsidiaries assume any liability whatsoever for any errors or inaccuracies of this document and the consequences thereof. Published specifications are subject to change without notice. Product suitability for any area of application must ultimately be determined by the customer. In all cases, products must never be operated outside their published specifications. Semiware does not guarantee the availability of all published products. This disclaimer shall be governed by substantive Chinese law and resulting disputes shall be settled by the courts at the place of business of Semiware. Latest publications and a complete disclaimer can be downloaded from the Semiware website. All trademarks recognized.